

[54] LIGHT-EMITTING DIODE
SEMICONDUCTOR CHIP WITH LEADS

4,186,996 2/1980 Bowen et al. 357/17 X

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[**] Term: 14 Years

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[52] U.S. Cl. D13/24

[58] Field of Search D13/13, 24, 99; 357/17, 357/74

[56] References Cited

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[57] CLAIM

The ornamental design for a light-emitting diode semiconductor chip with leads, substantially as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a light-emitting diode semiconductor chip with leads showing my new design; FIG. 2 is a front elevational view thereof; FIG. 3 is a side elevational view thereof, as seen from the right side of FIG. 1. FIG. 4 is a side elevational view thereof, as seen from the left side of FIG. 1; FIG. 5 is a top plan view thereof; and FIG. 6 is a bottom plan view thereof.

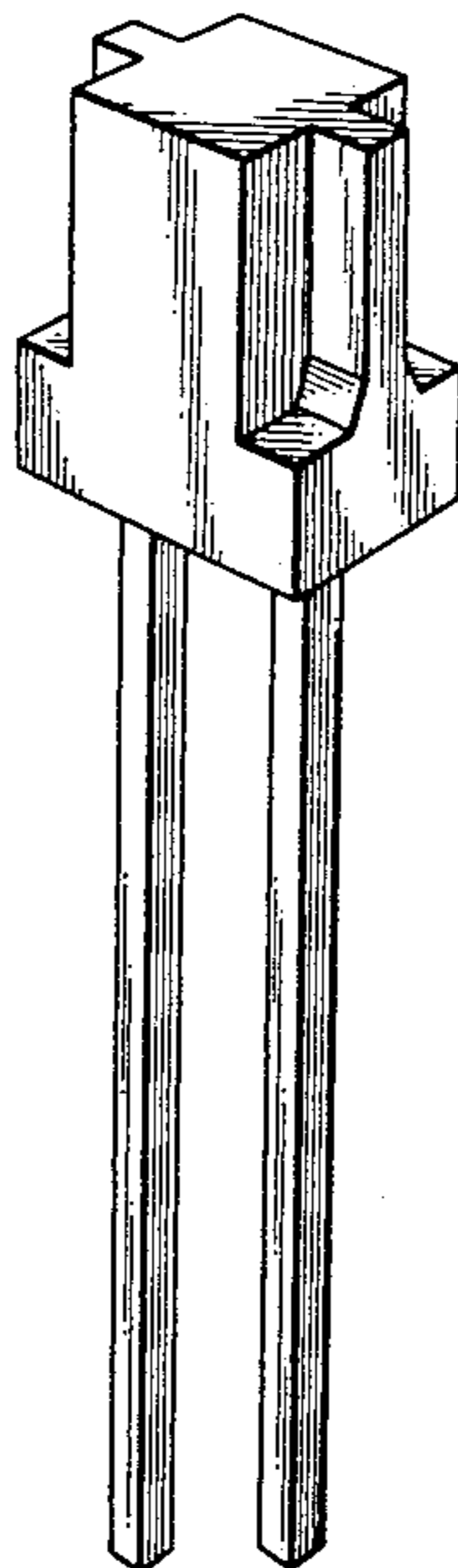


Fig.1

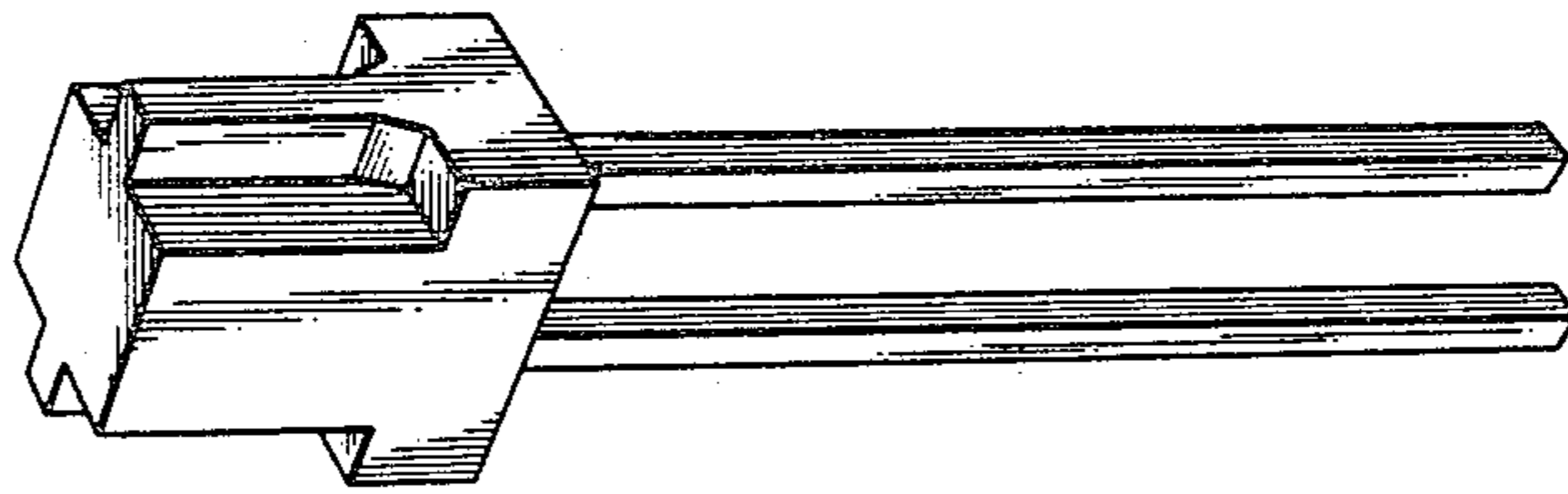


Fig. 2

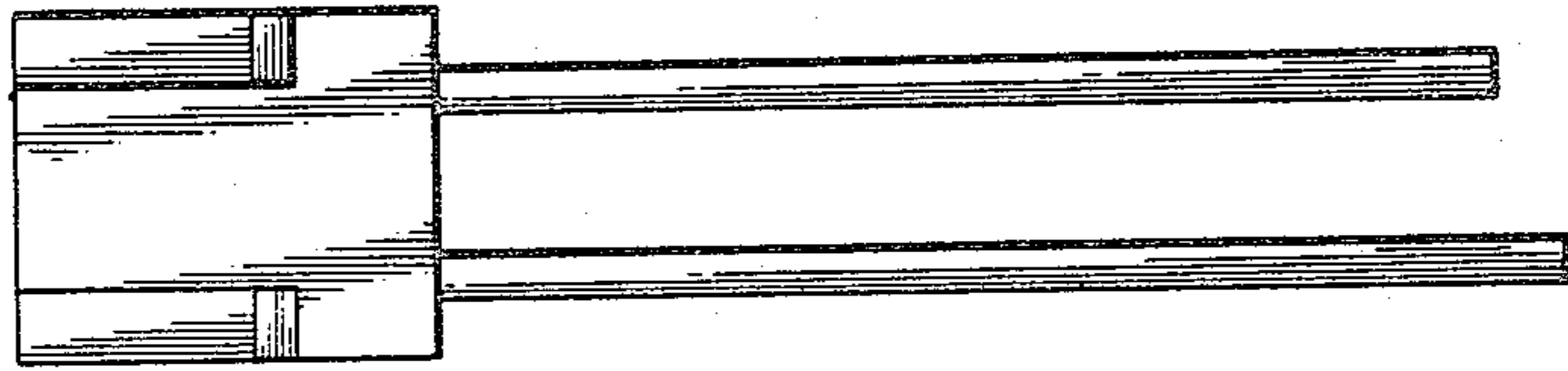


Fig. 3

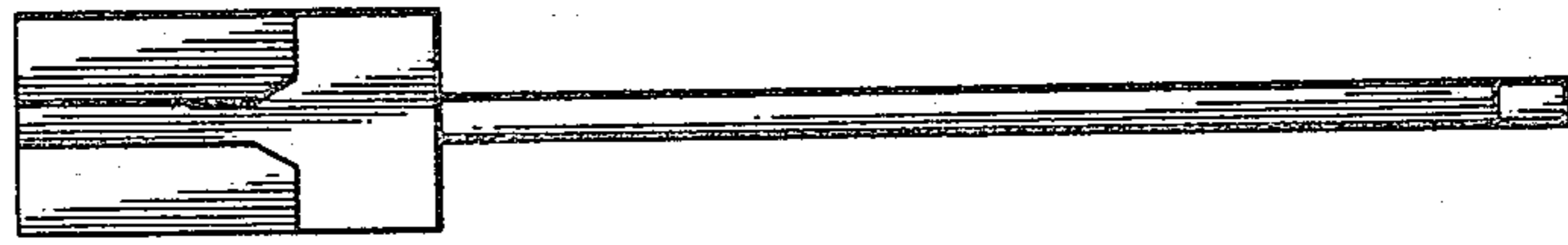


Fig. 4

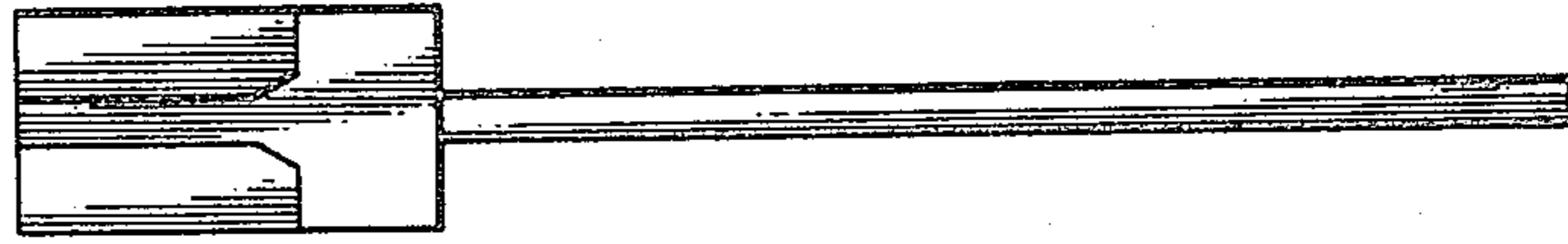


Fig. 5

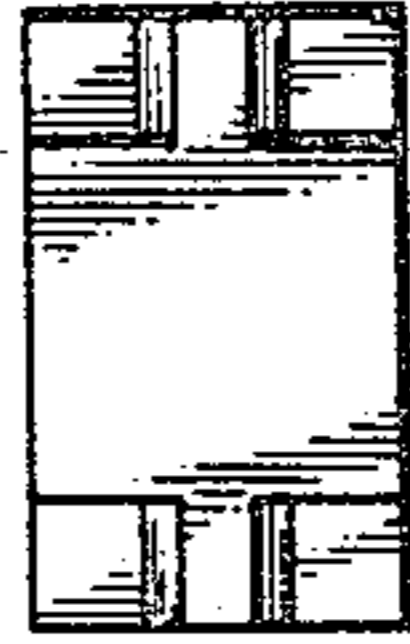


Fig. 6

